Land Pattern

Notice (Soldering and Mounting)

1. Standard Land Dimensions

A high Q value is achieved when the PCB electrode land pattern is designed so that it does not project beyond the chip coil electrode.

					Solder	Resist (in mm
Series	Standard	Land Dimensions				
LQG15H LQG18H		Part Number	а		b	С
LQM18N LQM21N/21D/21F LQM31F LQP03T LQP15M/15T LQP18M		LQG15H	0.5-0.6		-1.5	0.4
		LQG18H	0.6-0.8	3 1.8	-2.2	0.6-0.8
		LQM18N Reflow	0.7		-2.6	0.7
		LQM21N/21D/21F	1.0		-4.0	1.2
		LQM31F	1.2		-5.2	2.0
	b	LQP03T	0.2-0.3		-0.9	0.2-0.3
		LQP15M/15T	0.5-0.6	6 1.4	-1.5	0.4
		LQP18M	0.7-0.9	9 1.8	-2.2	0.6-0.8
LQW15A						
LQW18A	≪ →	Part Number	а	b	с	d
LQN21A LQW31H LQH31M/31C/31H		LQH31M/31C/31H LQW31H	1.5	4.5	1.75	1.0
		LQN21A	1.2	3.0	1.1	0.8
		LQW18A	0.7-1.0	1.8-2.0	0.6-0.7	0.6-0.8
	► 2.5min.*	LQW15A	0.65	1.2	0.35	0.50
	* 2.0 min. (LQW15A/18A)	If mounted at 2.5 (2.0) mm intervals as indicated in the diagram, attention should be paid to potential magnetic coupling effects whe using the coil as a resonator.				
LQH32M LQH32C LQH3KS						
LQH43M LQN4N LQH43C						
LQH55D LQH66S						

